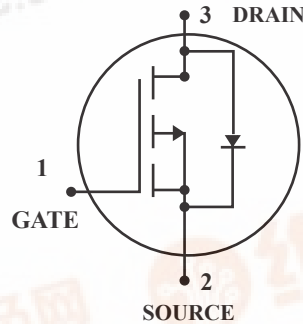




WTC2303

P-Channel Enhancement Mode Power MOSFET



DRAIN CURRENT

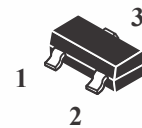
-1.9 AMPERES

DRAIN SOURCE VOLTAGE

-30 VOLTAGE

Features:

- *Super High Dense Cell Design For Low $R_{DS(ON)}$
 $R_{DS(ON)} < 240m\Omega @ V_{GS} = -10V$
- *Rugged and Reliable
- *Simple Drive Requirement
- *SOT-23 Package



SOT-23

Applications

- *Power Management in Notebook Computer
- *Portable Equipment
- *Battery Powered System

Maximum Ratings ($T_A = 25^\circ C$ Unless Otherwise Specified)

Rating	Symbol	Value	Unit
Drain-Source Voltage	V_{DS}	-30	V
Gate-Source Voltage	V_{GS}	± 20	
Continuous Drain Current ³ , ($T_A = 25^\circ C$) I_D , ($T_A = 70^\circ C$)	I_D	-1.9	A
		-1.5	
Pulsed Drain Current ^{1,2}	I_{DM}	-10	
Total Power Dissipation ($T_A = 25^\circ C$)	P_D	1.38	W
Maximum Thermal Resistance Junction-ambient ³	$R_{\theta JA}$	90	$^\circ C/W$
Operating Junction and Storage Temperature Range	T_J, T_{stg}	-55~+150	$^\circ C$

Device Marking

WTC2303-2303

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Electrical Characteristics ($T_A = 25^\circ\text{C}$ Unless otherwise noted)

Characteristic	Symbol	Min	Typ	Max	Unit
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Static

Drain-Source Breakdown Voltage $V_{GS}=0, I_D=-250\mu\text{A}$	$V_{(BR)DSS}$	-30	-	-	V
Gate-Source Threshold Voltage $V_{DS}=V_{GS}, I_D=-250\mu\text{A}$	$V_{GS(Th)}$	-1.0	-	-	
Gate-Source Leakage Current $V_{GS} = \pm 20\text{V}$	I_{GSS}	-	-	± 100	nA
Drain- Source Leakage Current($T_j=25^\circ\text{C}$) $V_{DS}=-30\text{V}, V_{GS}=0$	I_{DSS}	-	-	-1	μA
Drain- Source Leakage Current($T_j=70^\circ\text{C}$) $V_{DS}=-30\text{V}, V_{GS}=0$		-	-	-10	
Drain-Source On-Resistance ² $V_{GS}=-10\text{V}, I_D=-1.7\text{A}$ $V_{GS}=-4.5\text{V}, I_D=-1.3\text{A}$	$R_{DS(on)}$	- -	- -	240 460	$\text{m}\Omega$
Forward Transconductance $V_{DS}=-10\text{V}, I_D=-1.7\text{A}$	g_{fs}	-	2	-	S

Dynamic

Input Capacitance $V_{GS}=0\text{V}, V_{DS}=-15\text{V}, f=1.0\text{MHz}$	C_{iss}	-	230	-	pF
Output Capacitance $V_{GS}=0\text{V}, V_{DS}=-15\text{V}, f=1.0\text{MHz}$	C_{oss}	-	130.4	-	
Reverse Transfer Capacitance $V_{GS}=0\text{V}, V_{DS}=-15\text{V}, f=1.0\text{MHz}$	C_{rss}	-	40	-	

Switching

Turn-on Delay Time ² $V_{DS}=-15V, V_{GS}=-10V, I_D=-1A, R_D=15\Omega, R_G=6\Omega$	$t_{d(on)}$	-	7.6	-	ns
Rise Time $V_{DS}=-15V, V_{GS}=-10V, I_D=-1A, R_D=15\Omega, R_G=6\Omega$	t_r	-	8.2	-	
Turn-off Delay Time $V_{DS}=-15V, V_{GS}=-10V, I_D=-1A, R_D=15\Omega, R_G=6\Omega$	$t_{d(off)}$	-	17.5	-	
Fall Time $V_{DS}=-15V, V_{GS}=-10V, I_D=-1A, R_D=15\Omega, R_G=6\Omega$	t_f	-	9	-	
Total Gate Charge ² $V_{DS}=-15V, V_{GS}=-10V, I_D=-1.7A$	Q_g	-	6.2	10	nC
Gate-Source Charge $V_{DS}=-15V, V_{GS}=-10V, I_D=-1.7A$	Q_{gs}	-	1.4	-	
Gate-Drain Charge $V_{DS}=-15V, V_{GS}=-10V, I_D=-1.7A$	Q_{gd}	-	0.3	-	

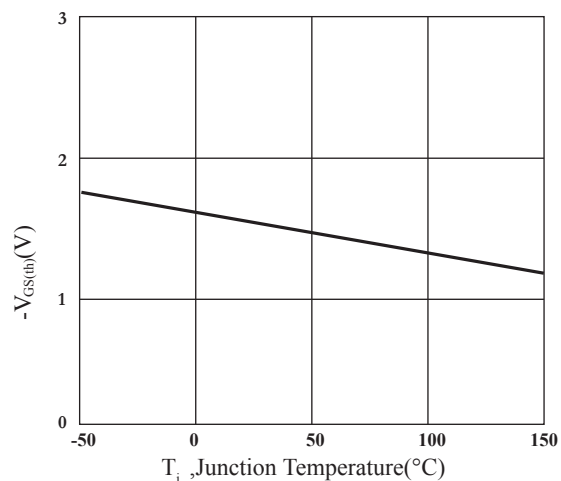
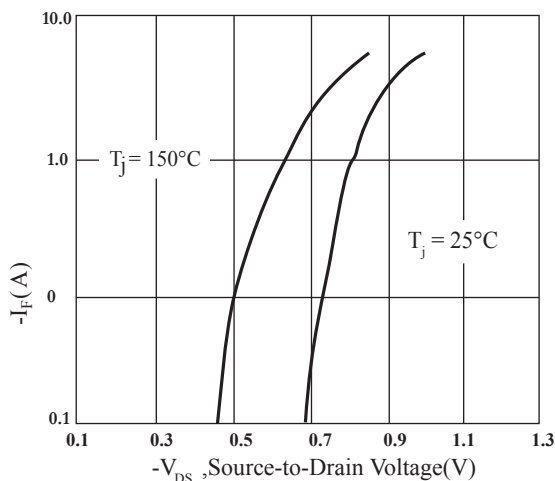
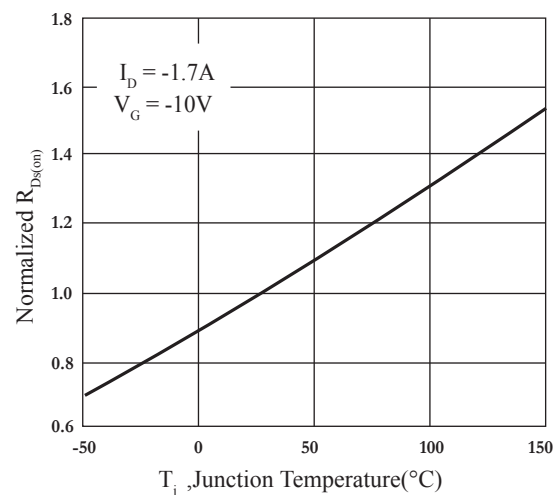
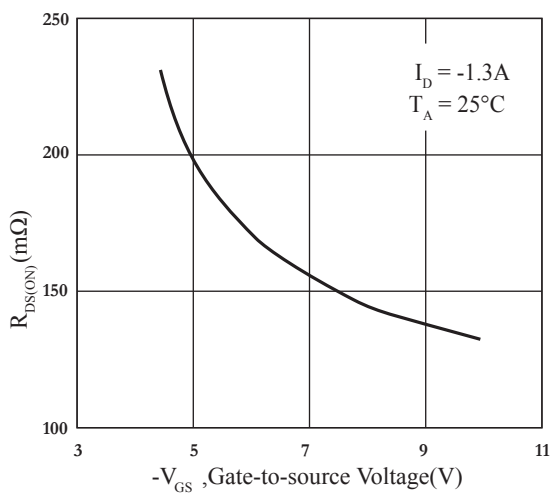
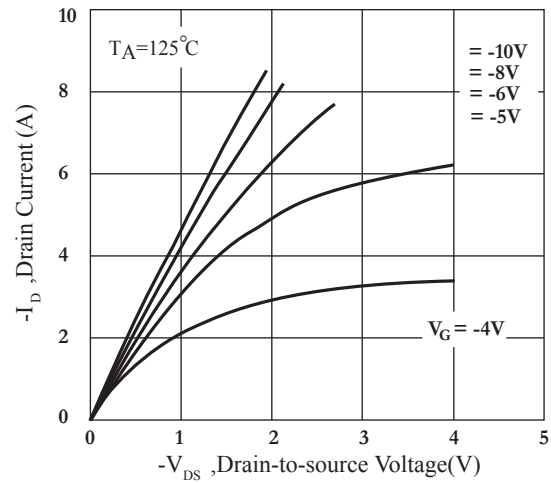
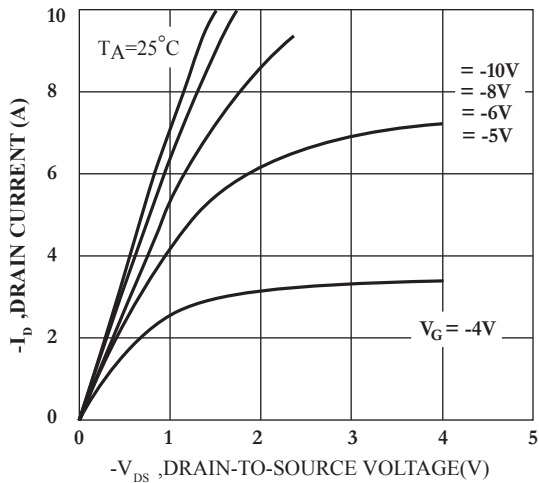
Source-Drain Diode Characteristics

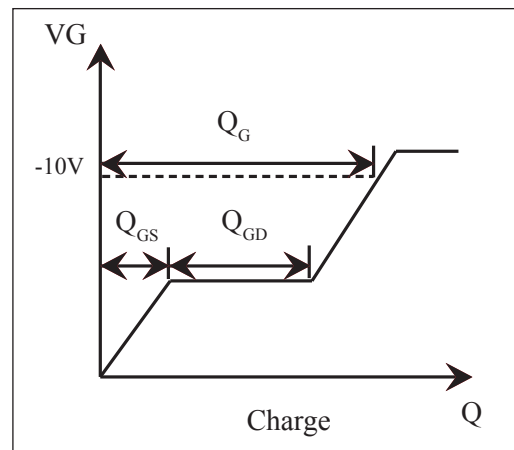
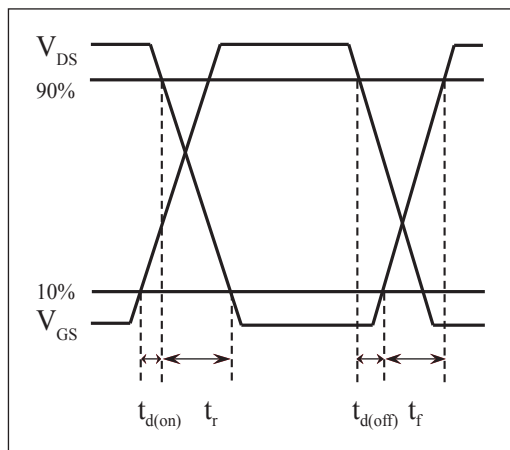
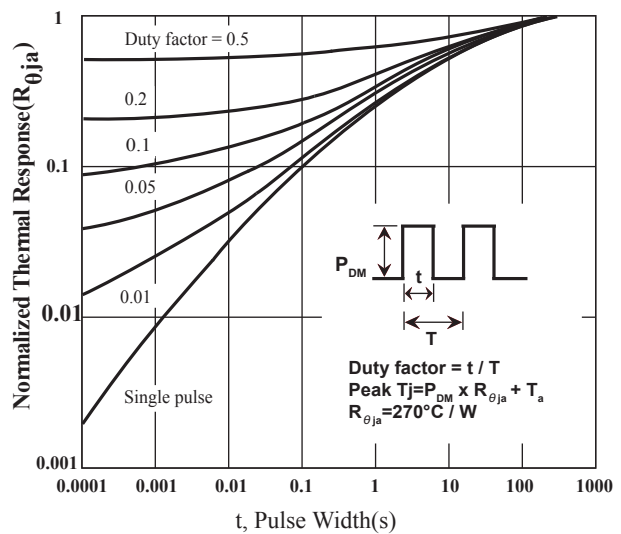
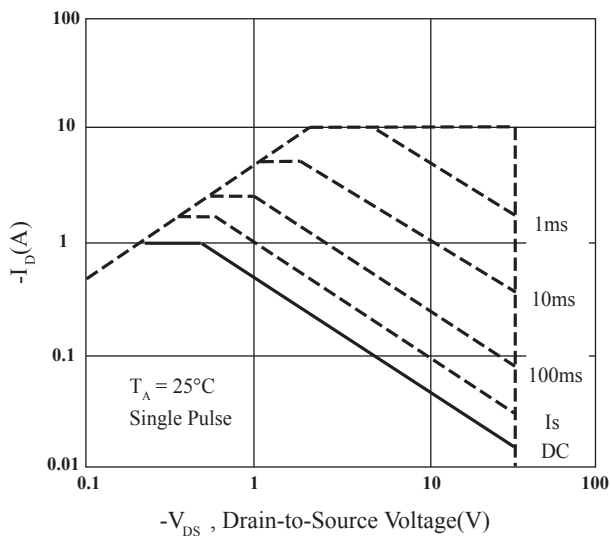
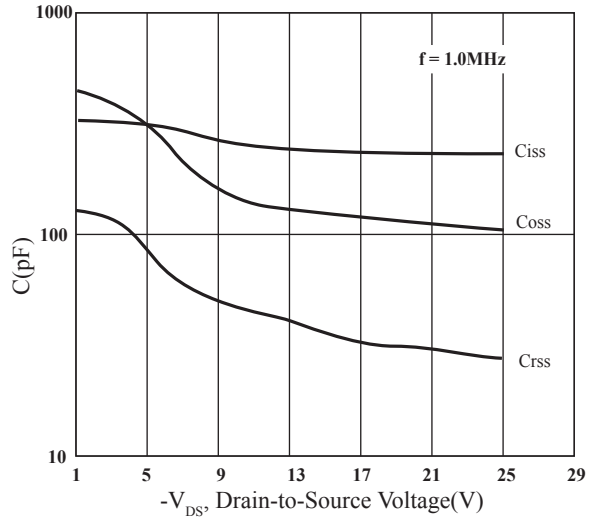
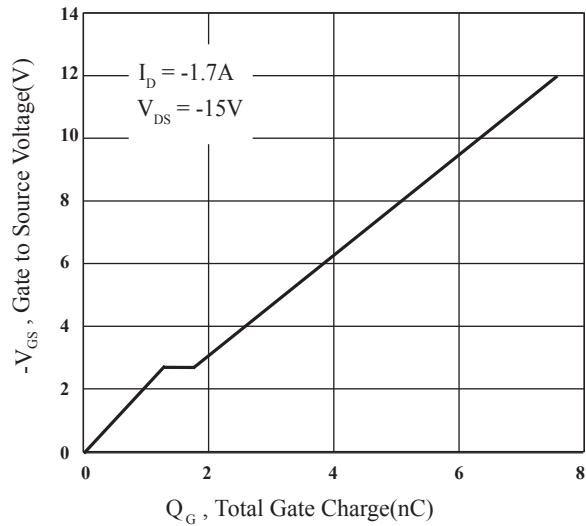
Forward On Voltage ² $V_{GS}=0V, I_S=-1.25A @T_j=25^\circ C$	V_{SD}	-	-	- 1.2	V
Continuous Source Current(Body Diode) $V_D=V_G=0V, V_S=-1.2V$	I_S	-	-	- 1	A
Pulsed Source Current(Body Diode) ¹	I_{SM}	-	-	- 10	A

Note: 1. Pulse width limited by Max, junction temperature.

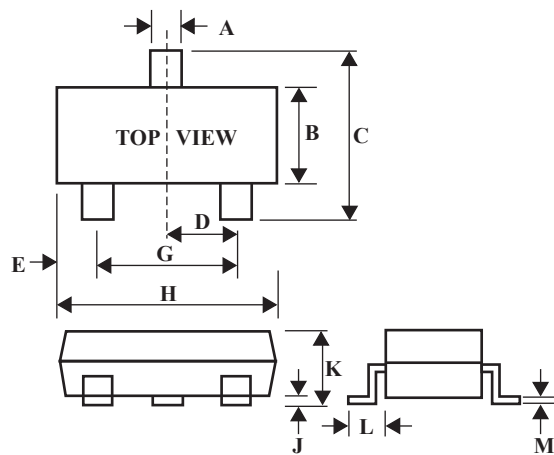
2. pulse width $\leq 300\mu s$, duty cycle $\leq 2\%$.

3. Surface mounted on 1 in² copper pad of FR4 board; 270°C/W when mounted on min, copper pad.





SOT-23 Outline Dimension



SOT-23		
Dim	Min	Max
A	0.35	0.51
B	1.19	1.40
C	2.10	3.00
D	0.85	1.05
E	0.46	1.00
G	1.70	2.10
H	2.70	3.10
J	0.01	0.13
K	0.89	1.10
L	0.30	0.61
M	0.076	0.25